

# <C band Internally Matched Power GaAs FET>

# MGFC42V7177

### 7.1 - 7.7GHz BAND / 16W

### **DESCRIPTION**

The MGFC42V7177 is an internally impedance-matched GaAs power FET especially designed for use in 7.1 – 7.7 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

### **FEATURES**

Crass A operation

Internally matched to 50(ohm)

• High output power: P1dB = 16 W (typ.) @ P1dB

• High power gain: GLP = 8.0 dB (typ.)

• High power added efficiency: PAE = 30 % (typ.)

### **APPLICATIONS**

• item 01: 7.1 – 7.7GHz band power amplifier

• item 51: 7.1 – 7.7GHz band digital radio communication

### **QUALITY**

• IG

### RECOMMENDED BIAS CONDITIONS

• Vds = 10 V • Ids = 4.5 A • Rg =  $25 \Omega$ 

Absolute maximum ratings (Ta = 25° C)

| Symbol | Parameter                       | Ratings      | Unit |
|--------|---------------------------------|--------------|------|
| VGDO   | Gate to drain breakdown voltage | -15          | V    |
| VGSO   | Gate to source breakdown        | -15          | V    |
| ID     | Drain current                   | 12           | Α    |
| IGR    | Reverse gate current            | -40          | mΑ   |
| IGF    | Forward gate current            | 84           | mA   |
| PT *1  | Total power dissipation         | 78.9         | W    |
| Tch    | Channel temperature             | 175          | °C   |
| Tstg   | Storage temperature             | - 65 to +175 | °C   |

\*1: Tc=25°C

# OUTLINE DRAWING Unit millimeters (inches) 24+/-0.3 R1.25 (1) 0.6+/-0.15 (2) 889 (2) 13.4 (1): GATE (2): SOURCE (FLANGE) (3): DRAIN

### Keep Safety first in your circuit designs!

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## **Electrical characteristics** (Ta = 25° C)

| Symbol       | Parameter                      | Test conditions                            | Limits |      |      | Unit  |
|--------------|--------------------------------|--|--------|------|------|-------|
|              |                                |  | Min.   | Тур. | Max. | Offic |
| VGS(off)     | Gate to sourse cut-off voltage | VDS = 3V, $ID = 80mA$                      | -2     | -3   | -4   | V     |
| P1dB         | 1dB gain comp. output power    | VDS = 10V,<br>ID = 4.5A,<br>f=7.1 – 7.7GHz | 41     | 42   | -    | dBm   |
| GLP          | Linear Power Gain              |  | 7      | 8    | -    | dB    |
| IDS (RF)     | Drain Current at P1dB          |  | -      | 4.5  | -    | Α     |
| η add        | Power added efficiency         |  | -      | 30   | -    | %     |
| IM3 *2       | 3rd order IM distortion        |  | -42    | -45  | -    | dBc   |
| Rth(ch-c) *3 | Thermal resistance             | Delta Vf Method                            | -      | -    | 1.9  | °C/W  |

\*2: item -51, 2 tone test, Po=32dBm single carrier level, f=7.7GHz, delta f=10MHz

\*3 : Channel to case

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